505663086 09/10/2019

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT5709892

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
BOK ENG CHEAH	09/06/2019
ENG HUAT GOH	09/06/2019
JACKSON CHUNG PENG KONG	09/06/2019
KHANG CHOONG YONG	09/10/2019
MIN SUET LIM	09/06/2019

RECEIVING PARTY DATA

Name:	INTEL CORPORATION
Street Address:	2200 MISSION COLLEGE BLVD.
City:	SANTA CLARA
State/Country:	CALIFORNIA
Postal Code:	95054

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16565639

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Correspondent Name: SCHWEGMAN LUNDBERG & WOESSNER/INTEL

Address Line 1: P.O. BOX 2938

Address Line 4: MINNEAPOLIS, MINNESOTA 55402

ATTORNEY DOCKET NUMBER:	1884.573US1
NAME OF SUBMITTER:	BETH MOON
SIGNATURE:	/Beth Moon/
DATE SIGNED:	09/10/2019

Total Attachments: 3

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PATENT REEL: 050323 FRAME: 0259

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PATENT REEL: 050323 FRAME: 0260

Intel Docket No.: AB3456-MY-US SLW Reference No.: 1884.573US1

<u>ASSIGNMENT</u>

In consideration of good and valuable consideration, the receipt of which is hereby acknowledged, we, the undersigned inventor(s):

<Bok Eng Cheah, Eng Huat Goh, Jackson Chung Peng Kong, Khang Choong Yong, Min Suet Lim>

hereby sell, assign, and transfer to:

Intel Corporation

a corporation of Delaware, having a principal place of business at 2200 Mission College Boulevard, Santa Clara, California, 95054 USA ("Assignee"), and its successors, assigns, and legal representatives, the entire right, title, and interest for the United States and all other countries, in and to any and all inventions and improvements that are disclosed in the application for the patent entitled:

FIBER WEAVE-SANDWICHED DIFFERENTIAL PAIR ROUTING TECHNIQUE

	10, 2019
which was filed on September	

which has been executed by the undersigned prior hereto or concurrently herewith on the date(s) indicated below.

and in and to said application and all Additional Applications, and all other patent applications that have been or shall be filed in the United States and all other countries and international filing offices on any of said inventions and improvements; and in and to all original and reissued patents that have been or shall be issued in the United States and all other countries and international filing offices on said inventions and improvements; and in and to all rights of priority resulting from the filing of said applications; as used herein "Additional Applications" includes but is not limited to design, utility, utility model, divisional, continuing, continuation-in-part, substitute, renewal, reissue, and national phase applications on said inventions and improvements;

and agree that said Assignee may apply for and receive a patent or patents for said inventions and improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns, and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all Additional Applications, and all other patent applications on any and all said inventions and improvements; execute

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PATENT REEL: 050323 FRAME: 0261

Intel Docket No.: AB3456-MY-US SLW Reference No.: 1884.573US1

all rightful oaths, assignments, powers of attorney, and other papers; communicate to said Assignee, its successors, assigns, and legal representatives all facts known to the undersigned relating to said inventions and improvements and the history thereof; and generally assist said Assignee, its successors, assigns, or legal representatives in securing and maintaining proper patent protection for said inventions and improvements and for vesting title to said inventions and improvements, and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

covenant with said Assignee, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Buttery Olich	6 scrienber 2019
Bok Eng Cheah	Date Signed
	9/6/2019
Eng Huat Goh	Date Signed
Joelson	9/6/2019
Jackson Chung Peng Kong	Date Signed
Khang Choong Yong	Date Signed
	9/6/2019
Mix Suet Lim	Date Signed

Intel Docket No.: AB3456-MY-US SLW Reference No.: 1884.573US1

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covenant with said Assignee, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Bok Eng Cheah	Date Signed
Eng Huat Goh	Date Signed
Jackson Chung Peng Kong	Date Signed
	10-501-2019
Khang Choong Yong	Date Signed
Min Suet Lim	Date Signed

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RECORDED: 09/10/2019